DXM/64x64 and DXM/128x128 SERIES
SOLID STATE HIGH SPEED DIFFERENTIAL DATA
SWITCHING MATRICES for RS422, ECL, PECL, CML & LVDS

CYTEC’s DXM Series switching systems are solid state, full fan-out matrices available in 16x16 through 128x128 configurations. Input and Output Buffers allow ECL, PECL, LVPECL, LVDS or fast RS422 two wire differential signal switching. Data rates are as high as 2 Gbps (NRZ). Control is via LAN / RS232 / GPIB or Manual.

TYPICAL APPLICATIONS INCLUDE:
• Programmable routing of signals for telemetry.
• Signal distribution for communications and test.
• Automated patch panels.

SYSTEM HIGHLIGHTS:
• Matrices are non-blocking and full fan out.
• 64x64 and 128x128 chassis sizes are offered.
• Modular design - Systems can be configured in increments from 16x16 to 128x128 matrix sizes.
• Buffer modules allow conversion between signals ECL in to LVDS out, RS422 in to ECL out, etc..
• Clock/Data configurations available.
• Buffer and control modules are hot-swappable.
• Control via LAN, RS232 or GPIB.
• Densi-Shield high density connectors for easy install.
• Patch panels with SMAs, BNC, Triax, etc.
• Switch fabric cleans up signal jitter and rise times.

DXM CHASSIS
The DXM Chassis are standard 19” rack mounting anodized aluminum chassis that are built with RS232, IEEE488 and Ethernet controls. Any input connects to any or even all outputs. Systems switching Clock & Data pairs are also available. Densi-Shield input and output connectors are standard, while other connectors such as SMA or BNC can be wired out on patch panels.
The following chassis are offered:
DXM/64x64 Mainframe- 5.25” high (3U) and 15.6 ” deep. Configurations range from 16x16 to 64x64 matrices.

DXM/32x32 Clock/Data Mainframe - also a 5.25”high and 15.6” deep chassis. Switches Clock & Data signals together in parallel. Available as 16x16 or 32x32 matrices.

DXM/128x128 Mainframe- 14” high (8U) and 15.6 ” deep. Configurations from 16x16 to 128x128 are offered.

DXM/64x64 Clock/Data Mainframe- Switches Clock & Data signals together as pairs. 8U by 15.6” deep. Available in configurations ranging from 16x16 to 64x64 matrices.

DXM-E Expansion Chassis - are used to build larger systems. Multiple DXM Chassis can be controlled from one MESA II Control Chassis shown as in the MESA Bulletin.
INPUT and OUTPUT BUFFER MODULES

The DXM Series switching systems are built with input and output buffer modules. Buffer modules are required to convert external signals (such as ECL, PECL, LVDS, etc.) to CML levels that can be handled by the solid state fabric at the heart of the switch. The switch fabric outputs CML levels which are then converted by the output buffers back to the original signal, or to a different signal type (i.e., ECL in to LVDS out) if required by the end user.

Each buffer module handles 16 differential signals. Thus, for a 16x16 configuration, one input and one output buffer module are required. Similarly, four input and four output buffer modules are needed for a 64x64 matrix, while eight of each are needed for a 128x128.

FCI DENSI-SHIELD I/O CONNECTORS AND CABLES

Each buffer is built with two Densi-shield connectors, and each connector handles eight differential pair signals. These connectors can be wired out using Densi-shield cables to optional patch panels with SMA, BNC, or Triax connectors.

Densi-shield Cables

- 8 pairs per cable
- 1/4 the size and weight of normal coax or twinax.
- Available in 1 to 10 meter lengths
- Passes 2.5 Gbps up to 3 meters, 1.25 to 10 Meters.
- Takes seconds to connect and disconnect.
- Better performance, simpler wiring, reduced cost.

INPUT/OUTPUT BUFFER SPECIFICATIONS

CML INPUT/OUTPUT BUFFER MODULES

The CML Input Module AC couples all inputs and provides pull up circuits to prevent unused inputs from floating and picking up crosstalk from live adjacent signals. CML Output Modules accept CML signals from the switch matrix crosspoint IC and pass them on to the output Densi-Shield connectors.

SPECIFICATIONS

| Specification                  | Value
<table>
<thead>
<tr>
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</thead>
<tbody>
<tr>
<td>Max. Data Rate (NRZ)</td>
<td>3.2 Gbps</td>
</tr>
<tr>
<td>Vdiff - Input Diff. Vpp</td>
<td>0.2 V min., 2.0 V max.</td>
</tr>
<tr>
<td>Vodiff - Output Diff. Vpp</td>
<td>0.5 V min., 0.8 V max.</td>
</tr>
<tr>
<td>Channel Propogation Delay</td>
<td>3.8 nsec. typ., 4.25 nsec max.</td>
</tr>
<tr>
<td>Ch-Ch Propogation Skew</td>
<td>75 psec typ., 125 psec max.</td>
</tr>
</tbody>
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FAST RS422 OUTPUT BUFFER MODULES

These modules are intended to work with typical RS422 signal levels of 0 to 5 volts. Differential signals terminate into 100 ohms across differential pairs. Vcc is typically 3.5 V for the inputs and 5 V for the output modules.

SPECIFICATIONS

| Specification                  | Value
<table>
<thead>
<tr>
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<tbody>
<tr>
<td>Max. Data Rate (NRZ)</td>
<td>60 Kbps min., 40 Mbps max.</td>
</tr>
<tr>
<td>Voh - Output V High</td>
<td>3.4 V min.</td>
</tr>
<tr>
<td>Vol - Output V Low</td>
<td>0.4 V max.</td>
</tr>
<tr>
<td>Channel Propogation Delay</td>
<td>3.8 nsec. typ., 4.25 nsec max.</td>
</tr>
<tr>
<td>Ch-Ch Propogation Skew</td>
<td>75 psec typ., 125 psec max.</td>
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LVDS OUTPUT BUFFER MODULES

Work with typical LVDS signal levels of 1 to 1.4 volts. Differential signals terminate into 100 ohms across differential pairs. Vcc is approximately 3.0 V.

SPECIFICATIONS

| Specification                  | Value
<table>
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<tr>
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<tbody>
<tr>
<td>Max. Data Rate (NRZ)</td>
<td>60 Kbps min., 1.6 Gbps max.</td>
</tr>
<tr>
<td>Voh - Output V High</td>
<td>1.474 V max.</td>
</tr>
<tr>
<td>Vol - Output V Low</td>
<td>.925 V min.</td>
</tr>
<tr>
<td>Vocm - Output Com Mode V</td>
<td>1.125 V min., 1.375 V max.</td>
</tr>
<tr>
<td>Vodiff - Output Diff. V</td>
<td>250 mV min., 450 mV max.</td>
</tr>
<tr>
<td>Channel Propogation Delay</td>
<td>3.8 nsec. typ., 4.25 nsec max.</td>
</tr>
<tr>
<td>Ch-Ch Propogation Skew</td>
<td>75 psec typ., 125 psec max.</td>
</tr>
</tbody>
</table>

ECL OUTPUT BUFFER MODULES

ECL modules are intended to work with typical ECL signal levels of -1.8 to -0.8 volts. Differential signals terminate into 50 ohms tied to -2 V. Vee is usually -5 V, while Vcc is GND.

SPECIFICATIONS

| Specification                  | Value
<table>
<thead>
<tr>
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<tbody>
<tr>
<td>Max. Data Rate (NRZ)</td>
<td>60 Kbps min., 3.0 Gbps max.</td>
</tr>
<tr>
<td>Voh - Output V High</td>
<td>-0.810 V max.</td>
</tr>
<tr>
<td>Vol - Output V Low</td>
<td>-1.950 V min.</td>
</tr>
<tr>
<td>Io - Output Current Continuous</td>
<td>50 mA</td>
</tr>
<tr>
<td>Channel Propogation Delay</td>
<td>3.8 nsec. typ., 4.25 nsec max.</td>
</tr>
<tr>
<td>Ch-Ch Propogation Skew</td>
<td>75 psec typ., 125 psec max.</td>
</tr>
</tbody>
</table>

FOR ASSISTANCE, CONTACT CYTEC AT 800-346-3117, e-mail sales@cytec-ate.com, OR VISIT cytec-ate.com
CONTROL & POWER SUPPLY REDUNDANCY/HOT SWAPPABILITY

DXM EXPANSION CHASSIS
DXM chassis can be built as expansion chassis and used with Cytec’s new MESA II Control Chassis. Expansion chassis allow large or complex systems to be set up using a single point of control. Using a MESA II Controller and one or more expansion chassis has the following advantages:

Cost Savings
Expansion chassis do not require their own control modules or manual controls, adding up to cost savings that pay for the MESA on any system requiring three or more expansion chassis.

Single Point of Control
You can control up to 16 DXM chassis, or combinations of different chassis types, from a single MESA II. The MESA allows control of several chassis from one GPIB address, RS232 Port or LAN IP address.

Remotely Located Switch Chassis
Expansion chassis can be located up to 125 feet away from the MESA. Thus switching chassis can be located where needed and still not require separate controls.

Complex Test Systems
Since any Cytec chassis can be controlled via the MESA, you can build complicated systems switching a number of different signal types by using different Cytec products for each signal type.

CONNECTORIZED PATCH PANEL OPTIONS
The DXM series chassis have I/O buffer modules that are built with high density Densi-shield connectors. These native connectors can be wired out to other common types including SMAs, BNCs, Triax, etc., located on separate rack mounting patch panels. (See adjacent image for a 16x16 matrix system using patch panel mounted Triax connectors)

REDUNDANT/HOT SWAPPABLE POWER SUPPLY CHASSIS
The DXM Series chassis are powered by either standard internal power supplies or optionally via externally located rack mounting power supply chassis. Each rack mounting power chassis holds several plug in, hot swappable power modules, with at least two redundant modules supplying each required voltage. The separate rack mounted power supply chassis increases system availability by furnishing supplies that are both redundant and hot swappable. (See adjacent image)

FOR TECHNICAL ASSISTANCE, PLEASE CONTACT CYTEC AT 800-346-3117 OR VISIT OUR WEBSITE AT cytec-ate.com
### DXM GENERAL SPECIFICATIONS

**Connections**
- Densi-Shield signal connections, AC input and remote control input. Optional signal connectors such as SMA, BNC and Triax are available on wired-out patch panels.
  
**Control**

### ENVIRONMENTAL

**Dimensions/Weight**
- DXM/64x64: 19” rack mount, less than 45 lbs, 5.25” high x 15.6” deep
- DXM/128x128: 14” high x 15.6” deep

**POWER**
- AC Input: 90-264 volts AC, 47-63 Hz, < 100 W typical
- DC Supply Type: High efficiency switching

**SIGNALS**
- **Capacity**
  - DXM/64x64: Up to 64x64 Matrix OR 32x32 Clock/Data configuration
  - DXM/128x128: Up to 128x128 Matrix OR 64x64 Clock/Data configuration
  - Expansion: Mesa Controller allows expansions up to 128x128 Clock and Data or higher.
- **Switch Fabric**
  - Vitesse VSC3138/VCS3140 crosspoint ICs CML inputs, CML outputs. Data rate to 3.5 Gbps NRZ helps restore signal levels, corrects deterministic jitter and rise time problems associated with long cable runs.

**MISCELLANEOUS**
- **Switching Speed**
  - 100 ns plus any computer delay
- **MTBF**
  - 50,000 hours (Telcordia)

### SOFTWARE

Free drivers and/or sample programs are available for the most commonly available application programming languages.

### CONTROL OPTIONS

**IF-11 ETHERNET LAN, IEEE488 and RS232**
- Standard for DXM/128x128 and DXM/64x64 Clock/Data Mainframes. All interfaces may be active and in use simultaneously. Setup information is stored in NVRAM, which allows the system to be configured for various matrix addressing combinations which are then remembered.

The LAN Interface has a static IP with three ports available and is 10/100BaseT compliant.

RS232 Control with selectable Baud rate. Also accepts any standard USB to RS232 adaptor cable allowing control from USB.

IEEE488 (GPIB) port is IEEE488.2 compliant.

### MANUAL CONTROL OPTIONS

**MC-2 Keypad Manual Control**
- This optional front panel control includes a keypad and LCD display. The operator can open, close and verify the status of any switch point.

### CUSTOMIZED SYSTEMS

Cytec can generally customize a system to meet specific requirements with little or no additional Non-Recurring Engineering (NRE) charges. Typical customizations include: special labeling, configurations, chassis dimensions and mounting options or components. Don’t see what you need? Contact Cytec and one of our Sales Engineers will be happy to work with you.

### CYTEC CONTROL SOFTWARE

Cytec offers open source Switch Manager software written in Microsoft VB.net®. We offer program examples and source code in the following platforms:
- National Instruments LabView® or LabWindows CVI®
- Mathworks Matlab®
- C, Java, Python, TCL
- Other languages or compilers on request.

### WARRANTY

CYTEC Corp. warrants that all products are free from defects in material or workmanship for a period of five years.

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DXM-2